

**PRODUCT / PROCESS CHANGE NOTIFICATION**

**1. PCN basic data**

<b>1.1 Company</b>		STMicroelectronics International N.V
<b>1.2 PCN No.</b>	POWER AND DISCRETES/25/15527	
<b>1.3 Title of PCN</b>	8 inches Wafer Diameter Conversion for Filter and ESD Protection devices at ST Tours (France)	
<b>1.4 Product Category</b>	Filter and ESD Protection devices	
<b>1.5 Issue date</b>	2025-07-24	

**2. PCN Team**

<b>2.1 Contact supplier</b>	
<b>2.1.1 Name</b>	KRISZTINA NEMETH
<b>2.1.2 Phone</b>	+49 89460062210
<b>2.1.3 Email</b>	krisztina.nemeth@st.com
<b>2.2 Change responsibility</b>	
<b>2.2.1 Product Manager</b>	Stephane CHAMARD
<b>2.1.2 Marketing Manager</b>	Philippe LEGER
<b>2.1.3 Quality Manager</b>	Jean-Paul REBRASSE

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
Manufacturing reshaping program	Manufacturing reshaping program	6inch ST Tours (France)

**4. Description of change**

	<b>Old</b>	<b>New</b>
<b>4.1 Description</b>	6inch ST Tours (France)	8inch ST Tours (France)
<b>4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?</b>	No impact	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	Following Corporate PCI 15383 (Early Notification), about Company reshaping program, please be informed that Die manufacturing line in 6 inches at ST Tours (France) for Filter and ESD Protection devices listed here below will be converted to 8 inches wafer diameter.
<b>5.2 Customer Benefit</b>	SERVICE CONTINUITY

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	Traceability of the change will be ensured by Finished Good/Type (Beginning with O letter) printed on carton labels.
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**7. Timing / schedule**

<b>7.1 Date of qualification results</b>	2026-04-30
<b>7.2 Intended start of delivery</b>	2026-07-31
<b>7.3 Qualification sample available?</b>	Upon Request

**8. Qualification / Validation**

<b>8.1 Description</b>			
<b>8.2 Qualification report and qualification results</b>	In progress	<b>Issue Date</b>	

**9. Attachments (additional documentations)**

15527 Public product.pdf  
15527 TAP Filtre indus 8inch.pdf

10. Affected parts		
10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	EMIF02-1003M6	
	EMIF03-SIM02M8	
	EMIF04-1005M8	
	EMIF06-1005M12	
	EMIF06-MSD02N16	
ESDA14V2L	ESDA14V2L	
ESDA19SC6	ESDA19SC6	
	ESDA25-4BP6	
ESDA25W	ESDA25W	
ESDA5V3L	ESDA5V3L	
	ESDA5V3SC5	
	ESDA5V3SC6	
ESDA6V1-5SC6	ESDA6V1-5SC6	
ESDA6V1-5W6	ESDA6V1-5W6	
ESDA6V1L	ESDA6V1L	
ESDA6V1SC6	ESDA6V1SC6	
ESDA6V1U1RL	ESDA6V1U1RL	
ESDA6V1W5	ESDA6V1W5	
	ESDALC6V1-1M2	
	ESDALC6V1-5P6	
ESDALC6V1P6	ESDALC6V1P6	
	SM2T3V3A	
SMLVT3V3	SMLVT3V3	
USBUF01W6	USBUF01W6	
USBUF02W6	USBUF02W6	
ESDA14V2BP6	ESDA14V2BP6	
ESDA14V2SC6	ESDA14V2SC6	
ESDA6V1-4BC6	ESDA6V1-4BC6	
ESDA6V1SC5	ESDA6V1SC5	
	ESDALC6V1P5	
	ESDALC6V1M3	
ESDALC6V1W5	ESDALC6V1W5	

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